

8-INPUT MULTIPLEXER/REGISTER; 3-STATE

FEATURES

- Non-transparent data latches
- Transparent address latch
- Easily expanding
- Complementary outputs
- Output capability: bus driver
- I_{CC} category: MSI

GENERAL DESCRIPTION

The 74HC/HCT356 are high-speed Si-gate CMOS devices and are pin compatible with low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74HC/HCT356 data selectors/multiplexers contain full on-chip binary decoding, to select one-of-eight data sources. The data select address is stored in transparent latches that are enabled by a LOW on the latch enable input $\overline{LE}$.

Data on the 8 input lines (D_0 to D_7) is clocked into a edge-triggered data register by a LOW-to-HIGH transition of the clock (CP).

When the output enable input $\overline{OE}_1 = \text{HIGH}$, $\overline{OE}_2 = \text{HIGH}$ or $\overline{OE}_3 = \text{LOW}$, the outputs go to the high impedance OFF-state.

Operation of these output enable inputs does not affect the state of the latches and register.

SYMBOL	PARAMETER	CONDITIONS	TYPICAL		UNIT
			HC	HCT	
t_{PHL}/t_{PLH}	propagation delay S_n , $\overline{LE}$ to Y , $\overline{Y}$ CP to Y , $\overline{Y}$	$C_L = 15 \text{ pF}$ $V_{CC} = 5 \text{ V}$	24 20	25 22	ns ns
C_I	input capacitance		3.5	3.5	pF
C_{PD}	power dissipation capacitance per package	notes 1 and 2	123	125	pF

$GND = 0 \text{ V}$; $T_{amb} = 25^\circ\text{C}$; $t_r = t_f = 6 \text{ ns}$

Notes

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz
 f_o = output frequency in MHz
 $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs
 C_L = output load capacitance in pF
 V_{CC} = supply voltage in V

2. For HC the condition is $V_I = GND$ to V_{CC}
For HCT the condition is $V_I = GND$ to $V_{CC} - 1.5 \text{ V}$

PACKAGE OUTLINES

20-lead DIL; plastic (SOT146).

20-lead mini-pack; plastic (SO20; SOT163A).

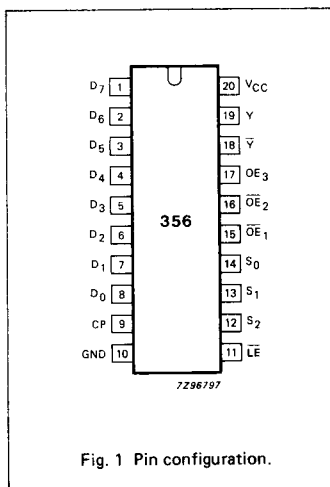


Fig. 1 Pin configuration.

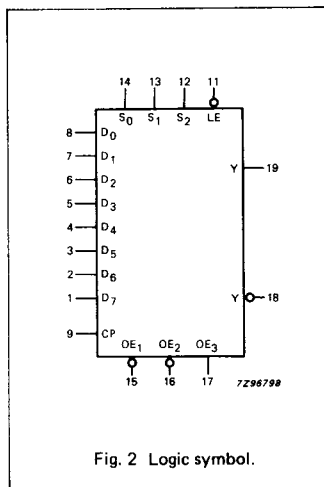


Fig. 2 Logic symbol.

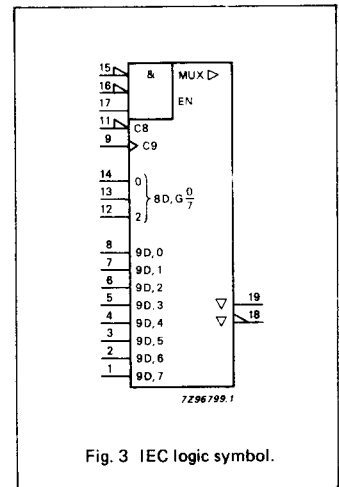


Fig. 3 IEC logic symbol.

PIN DESCRIPTION

PIN NO.	SYMBOL	NAME AND FUNCTION
8, 7, 6, 5, 4, 3, 2, 1	D_0 to D_7	data inputs
9	CP	clock input data (LOW-to-HIGH, edge-triggered)
10	GND	ground (0 V)
11	$\overline{LE}$	address latch enable input (active LOW)
14, 13, 12	S_0, S_1, S_2	select inputs
15, 16	$\overline{OE}_1, \overline{OE}_2$	output enable inputs (active LOW)
17	OE_3	output enable input (active HIGH)
18	$\overline{Y}$	3-state multiplexer output (active LOW)
19	Y	3-state multiplexer output (active HIGH)
20	V_{CC}	positive supply voltage

FUNCTION TABLE

INPUTS							OUTPUTS		DESCRIPTION
ADDRESS *			CP	OUTPUT ENABLE			Y	$\overline{Y}$	
S ₂	S ₁	S ₀		$\overline{OE}_1$	$\overline{OE}_2$	OE ₃			
X	X	X	X	H	X	X	Z	Z	outputs in high impedance OFF-state
X	X	X	X	X	H	X	Z	Z	
X	X	X	X	X	X	L	Z	Z	
L	L	L	↑	L	L	H	D _{0n}	$\overline{D}_{0n}$	data is clocked into latch
L	L	H	↑	L	L	H	D _{1n}	$\overline{D}_{1n}$	
L	L	L	↑	L	L	H	D _{2n}	$\overline{D}_{2n}$	
L	L	H	↑	L	L	H	D _{3n}	$\overline{D}_{3n}$	
H	L	L	↑	L	L	H	D _{4n}	$\overline{D}_{4n}$	
H	L	H	↑	L	L	H	D _{5n}	$\overline{D}_{5n}$	
H	H	L	↑	L	L	H	D _{6n}	$\overline{D}_{6n}$	
H	H	H	↑	L	L	H	D _{7n}	$\overline{D}_{7n}$	
L	L	L	**	L	L	H	D _{0p}	$\overline{D}_{0p}$	outputs do not change states
L	L	H	**	L	L	H	D _{1p}	$\overline{D}_{1p}$	
L	L	L	**	L	L	H	D _{2p}	$\overline{D}_{2p}$	
L	L	H	**	L	L	H	D _{3p}	$\overline{D}_{3p}$	
H	L	L	**	L	L	H	D _{4p}	$\overline{D}_{4p}$	
H	L	H	**	L	L	H	D _{5p}	$\overline{D}_{5p}$	
H	H	L	**	L	L	H	D _{6p}	$\overline{D}_{6p}$	
H	H	H	**	L	L	H	D _{7p}	$\overline{D}_{7p}$	

D_{0n} to D_{7n} = data present at inputs D_0 to D_7 when the data latch clock made the transition from LOW-to-HIGH

D_{0p} to D_{7p} = data previously latched into the data latch by the LOW-to-HIGH transition of the data latch clock

H = HIGH voltage level

L = LOW voltage level

X = don't care

↑ = LOW-to-HIGH CP transition

↓ = HIGH-to-LOW CP transition

Z = high impedance OFF-state

* This column shows the input address set-up with $\overline{LE}$ = LOW (address latch is transparent).

** CP is HIGH, LOW or ↓.

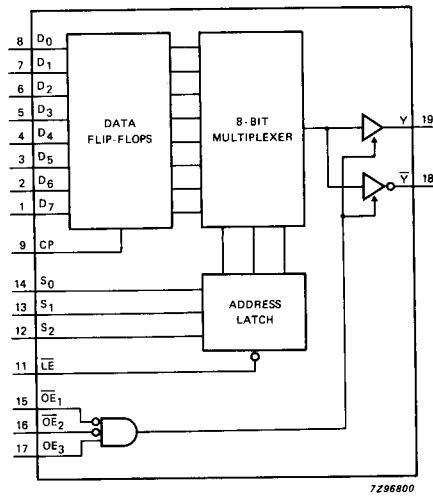


Fig. 4 Functional diagram.

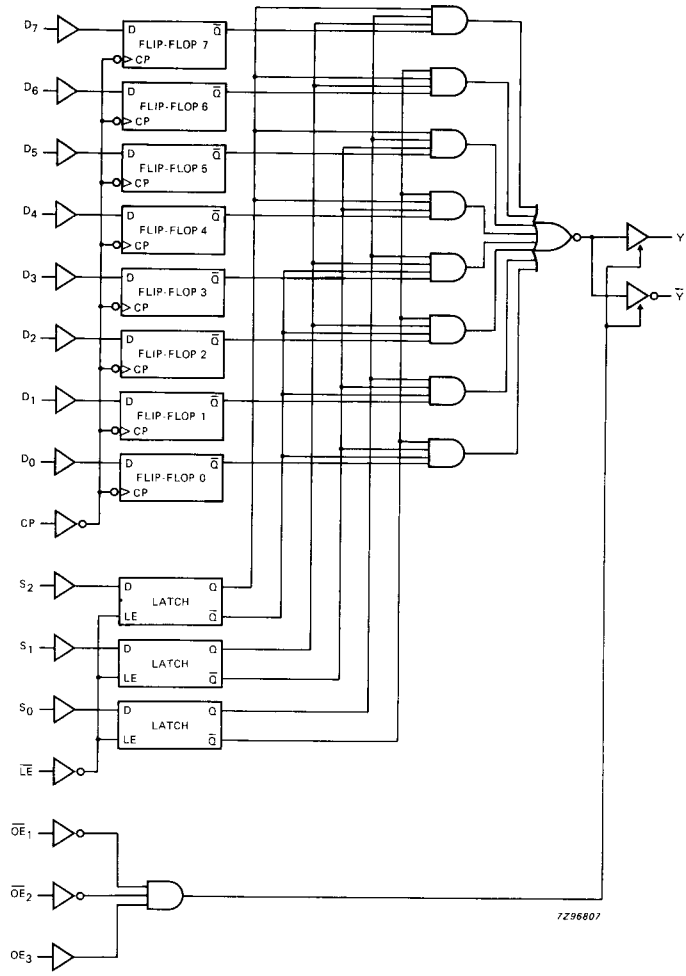


Fig. 5 Logic diagram.

DC CHARACTERISTICS FOR 74HC

For the DC characteristics see chapter "HCMOS family characteristics", section "Family specifications".

Output capability: bus driver

I_{CC} category: MSI**AC CHARACTERISTICS FOR 74HC**GND = 0 V; t_r = t_f = 6 ns; C_L = 50 pF

SYMBOL	PARAMETER	T _{amb} (°C)								UNIT	TEST CONDITIONS	
		74HC									V _{CC} V	WAVEFORMS
		+25			-40 to +85		-40 to +125					
		min.	typ.	max.	min.	max.	min.	max.				
t _{PHL} / t _{PLH}	propagation delay CP to Y, $\bar{Y}$		66 24 19	240 48 41		300 60 51		360 72 61	ns	2.0 4.5 6.0	Fig. 6	
t _{PHL} / t _{PLH}	propagation delay S _N to Y, $\bar{Y}$		77 28 22	260 52 44		325 65 55		390 78 66	ns	2.0 4.5 6.0	Fig. 7	
t _{PHL} / t _{PLH}	propagation delay LE to Y, $\bar{Y}$		77 28 22	270 54 46		340 68 58		405 81 69	ns	2.0 4.5 6.0	Fig. 8	
t _{PZH} / t _{PZL}	3-state output enable time OE _N to Y, $\bar{Y}$		41 15 12	125 25 21		155 31 26		190 38 32	ns	2.0 4.5 6.0	Fig. 11	
t _{PZH} / t _{PZL}	3-state output enable time OE ₃ to Y, $\bar{Y}$		47 17 14	150 30 26		190 38 33		225 45 38	ns	2.0 4.5 6.0	Fig. 11	
t _{PHZ} / t _{PLZ}	3-state output disable time OE _N to Y, $\bar{Y}$		50 18 14	155 31 26		195 39 33		235 47 40	ns	2.0 4.5 6.0	Fig. 11	
t _{PHZ} / t _{PLZ}	3-state output disable time OE ₃ to Y, $\bar{Y}$		58 21 17	155 31 26		195 39 33		235 47 40	ns	2.0 4.5 6.0	Fig. 11	
t _{THL} / t _{TLH}	output transition time		14 5 4	60 12 10		75 15 13		90 18 15	ns	2.0 4.5 6.0	Figs 6, 7 and 8	
t _W	clock pulse width CP HIGH or LOW	80 16 14	17 6 5		100 20 17		120 24 20		ns	2.0 4.5 6.0	Fig. 6	
t _W	latch enable pulse width LE LOW	80 16 14	17 6 5		100 20 17		120 24 20		ns	2.0 4.5 6.0	Fig. 8	
t _{su}	set-up time D _N to CP	50 10 9	11 4 3		65 13 11		75 15 13		ns	2.0 4.5 6.0	Fig. 10	
t _{su}	set-up time S _N to LE	50 10 9	14 5 4		65 13 11		75 15 13		ns	2.0 4.5 6.0	Fig. 9	
t _h	hold time D _N to CP	5 5 5	-6 -2 -2		5 5 5		5 5 5		ns	2.0 4.5 6.0	Fig. 10	
t _h	hold time S _N to LE	5 5 5	-8 -3 -2		5 5 5		5 5 5		ns	2.0 4.5 6.0	Fig. 9	

DC CHARACTERISTICS FOR 74HCT

For the DC characteristics see chapter "HCMOS family characteristics", section "Family specifications".

Output capability: bus driver

I_{CC} category: MSI

Note to HCT types

The value of additional quiescent supply current (ΔI_{CC}) for a unit load of 1 is given in the family specifications. To determine ΔI_{CC} per input, multiply this value by the unit load coefficient shown in the table below.

INPUT	UNIT LOAD COEFFICIENT
D _n , S _n	0.2
OE ₃	0.25
LE	0.5
OE _n , CP	1.0

AC CHARACTERISTICS FOR 74HCT

GND = 0 V; t_r = t_f = 6 ns; C_L = 50 pF

SYMBOL	PARAMETER	T _{amb} (°C)							UNIT	TEST CONDITIONS	
		74HCT								V _{CC} V	WAVEFORMS
		+25			−40 to +85		−40 to +125				
		min.	typ.	max.	min.	max.	min.	max.			
t _{PHL} / t _{PLH}	propagation delay CP to Y, $\bar{Y}$		26	51		64		77	ns	4.5	Fig. 6
t _{PHL} / t _{PLH}	propagation delay S _N to Y, $\bar{Y}$		28	59		74		89	ns	4.5	Fig. 7
t _{PHL} / t _{PLH}	propagation delay LE to Y, $\bar{Y}$		29	63		79		95	ns	4.5	Fig. 8
t _{PZH} / t _{PZL}	3-state output enable time OE _N to Y, $\bar{Y}$		17	34		43		51	ns	4.5	Fig. 11
t _{PZH} / t _{PZL}	3-state output enable time OE ₃ to Y, $\bar{Y}$		18	34		43		51	ns	4.5	Fig. 11
t _{PHZ} / t _{PLZ}	3-state output disable time OE _N to Y, $\bar{Y}$		17	33		41		50	ns	4.5	Fig. 11
t _{PHZ} / t _{PLZ}	3-state output disable time OE ₃ to Y, $\bar{Y}$		20	33		41		50	ns	4.5	Fig. 11
t _{THL} / t _{TLH}	output transition time		5	12		15		18	ns	4.5	Figs 6, 7 and 8
t _W	clock pulse width CP HIGH or LOW	16	8		20		24		ns	4.5	Fig. 6
t _W	latch enable pulse width LE LOW	16	6		20		24		ns	4.5	Fig. 8
t _{su}	set-up time D _N to CP	10	4		13		15		ns	4.5	Fig. 10
t _{su}	set-up time S _N to LE	10	5		13		15		ns	4.5	Fig. 9
t _h	hold time D _N to CP	5	0		5		5		ns	4.5	Fig. 10
t _h	hold time S _N to LE	5	−2		5		5		ns	4.5	Fig. 9

AC WAVEFORMS

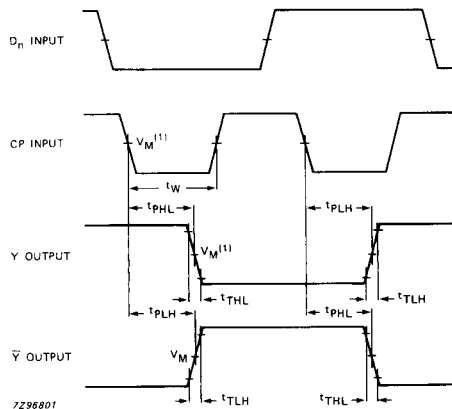


Fig. 6 Waveforms showing the clock (CP) to the output (Y, $\bar{Y}$) propagation delays, the clock pulse width and the output transition times.

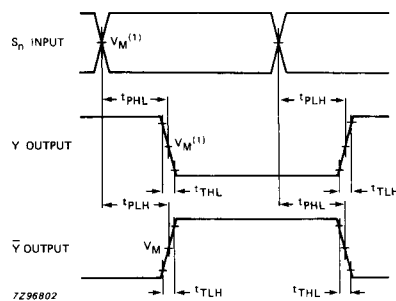


Fig. 7 Waveforms showing the select input (S_n) to output (Y, $\bar{Y}$) propagation delays and the output transition times ($\bar{LE} = \text{LOW}$).

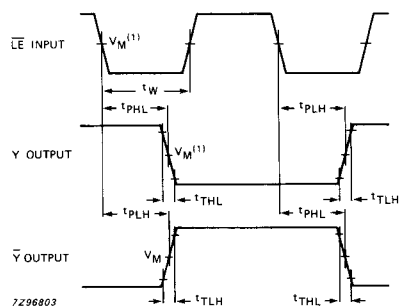


Fig. 8 Waveforms showing the address latch enable input ($\bar{LE}$) pulse width, the latch enable input to output (Y, $\bar{Y}$) propagation delays and the output transition times.

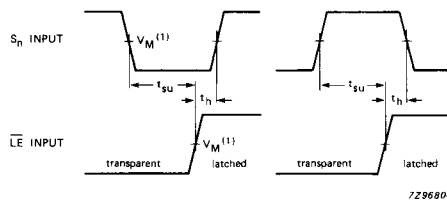


Fig. 9 Waveforms showing the set-up and hold times for the select input (S_n) to the address latch enable input ($\bar{LE}$).

AC WAVEFORMS

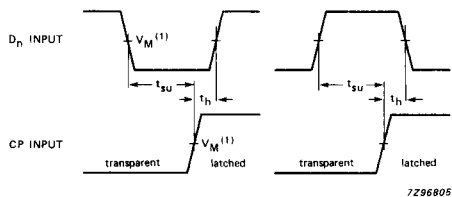


Fig. 10 Waveforms showing the set-up and hold times for the data input (D_n) to the clock (CP).

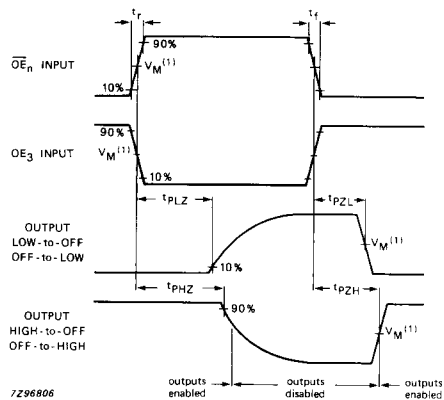


Fig. 11 Waveforms showing the 3-state enable and disable times.

Note to AC waveforms

- (1) HC : $V_M = 50\%$; $V_I = \text{GND to } V_{CC}$.
HCT: $V_M = 1.3 \text{ V}$; $V_I = \text{GND to } 3 \text{ V}$.

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9